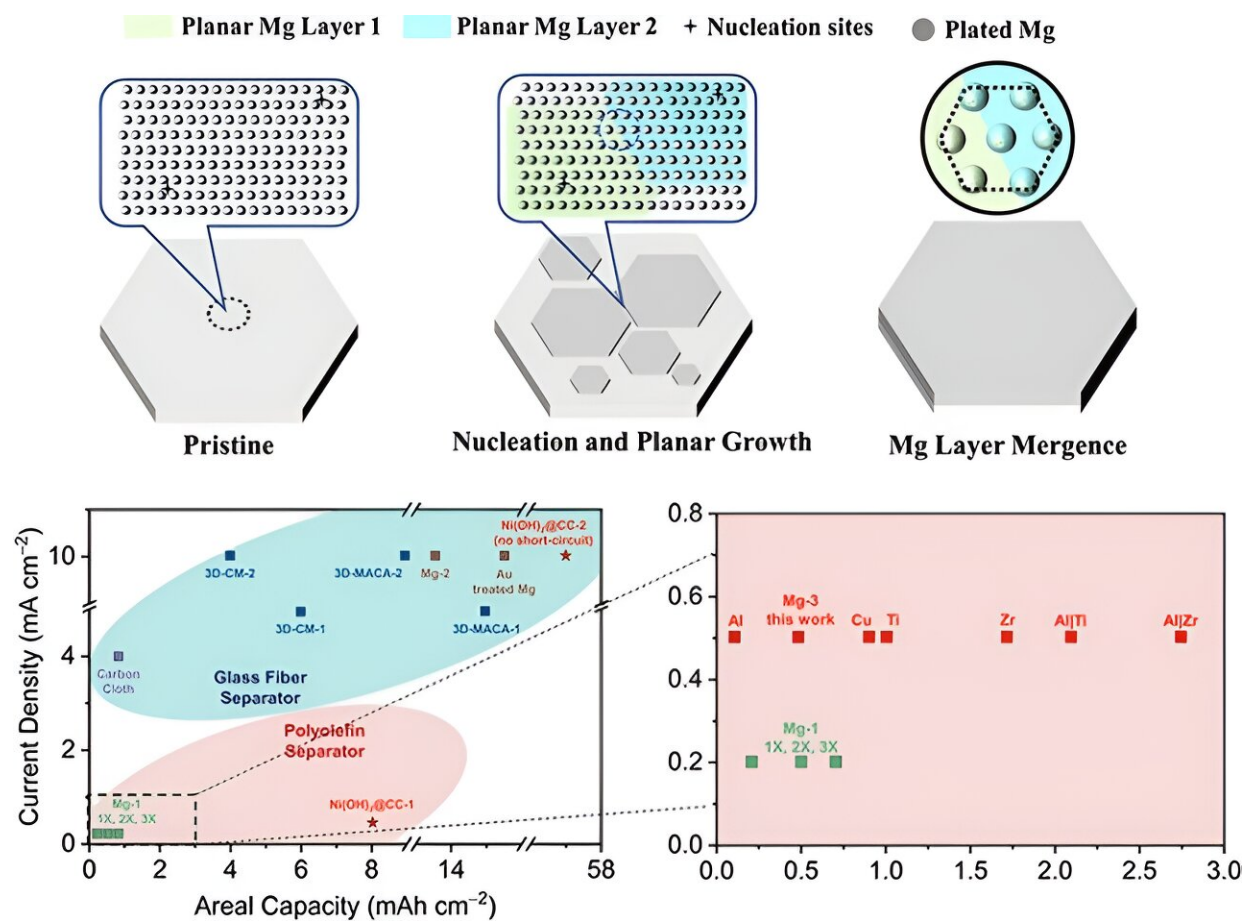


# A 3D magnesiophilic substrate enables planar electroplating/stripping of magnesium metal anode

December 27 2023, by Zhang Nannan



Schematic diagram of layer-by-layer planar growth model of Mg deposits and the performance comparison of various electroplating substrates. Credit: Wang Guixin & Du Aobing

As a promising candidate to current lithium-ion batteries, rechargeable magnesium batteries have attracted extensive attention due to the superior properties of magnesium (Mg) metal anodes, such as high volumetric capacity (3,833 mAh/cm<sup>3</sup>), abundant resources, environmental friendliness, and difficult to grow dendrites.

Although some studies have reported that the morphology of Mg dendrites can be observed under extreme electroplating conditions, such as using the limited Mg electrolytes with low Mg-ion conductivity and applying ultra-high [current density](#) (10 mAh/cm<sup>2</sup>), these test conditions are clearly different from practical requirements.

Researchers from the Qingdao Institute of Bioenergy and Bioprocess Technology of the Chinese Academy of Sciences (CAS) have discovered that the use of the practical polyolefin separator indeed causes the short-circuit of coin cell even at the low current density. They have established a layer-by-layer planar growth model for short-circuit suppression, and proposed the design strategy of a 3D magnesiophilic substrate to achieve planar Mg electroplating/stripping behavior.

The study was published in [ACS Energy Letters](#) on Dec. 4.

Ample evidence has shown that Mg growth is uniform and dense when the current density is below 5 mAh/cm<sup>2</sup>. However, using practical polyolefin separators with the thin thickness, low-current charging and discharging can cause internal short-circuiting in coin cells.

The researchers have proposed the island-growth model for Mg deposits based on electrochemical tests and microscopic morphology observation, which reasonably explains the abnormal short-circuit behavior.

By further adjusting the lattice mismatch parameters and the surface energy of the substrate, the layer-by-layer planar growth of Mg deposits

is achieved, effectively solving the above abnormal short-circuit problem.

The researchers used a magnesiophilic 3D substrate ( $\text{Ni}(\text{OH})_2@\text{CC}$ ) with low lattice mismatch and high surface energy properties as an electroplating substrate, which not only enabled the reversible electroplating/stripping process, but also matched with a high-load  $\text{Mo}_6\text{S}_8$  cathode ( $30 \text{ mg/cm}^2$ ).

By thoroughly exploring the short-circuit phenomenon caused by abnormal non-dendritic electroplating behavior in RMBs and proposing validated solutions, this work provides an important driving force for the practical application of Mg metal anode.

**More information:** Guixin Wang et al, Achieving Planar Electroplating/Stripping Behavior of Magnesium Metal Anode for a Practical Magnesium Battery, *ACS Energy Letters* (2023). [DOI: 10.1021/acsenergylett.3c02058](https://doi.org/10.1021/acsenergylett.3c02058)

Provided by Chinese Academy of Sciences

Citation: A 3D magnesiophilic substrate enables planar electroplating/stripping of magnesium metal anode (2023, December 27) retrieved 14 August 2024 from <https://phys.org/news/2023-12-3d-magnesiophilic-substrate-enables-planar.html>

This document is subject to copyright. Apart from any fair dealing for the purpose of private study or research, no part may be reproduced without the written permission. The content is provided for information purposes only.